

# EUV Actinic Mask Imaging with the SEMATECH Berkeley *Actinic Inspection Tool* (AIT)

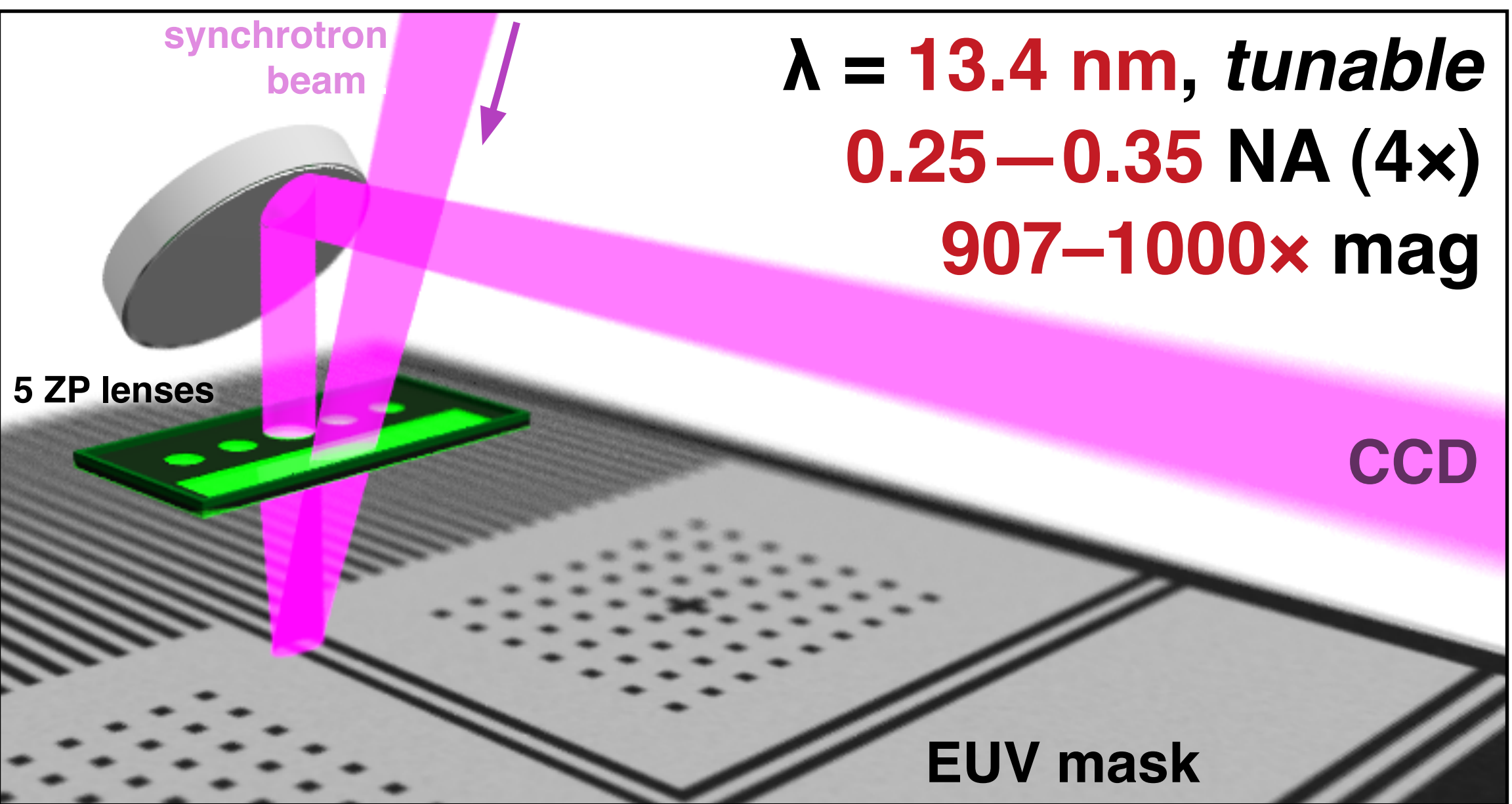
## A pathway to 8 nm EUVL and beyond

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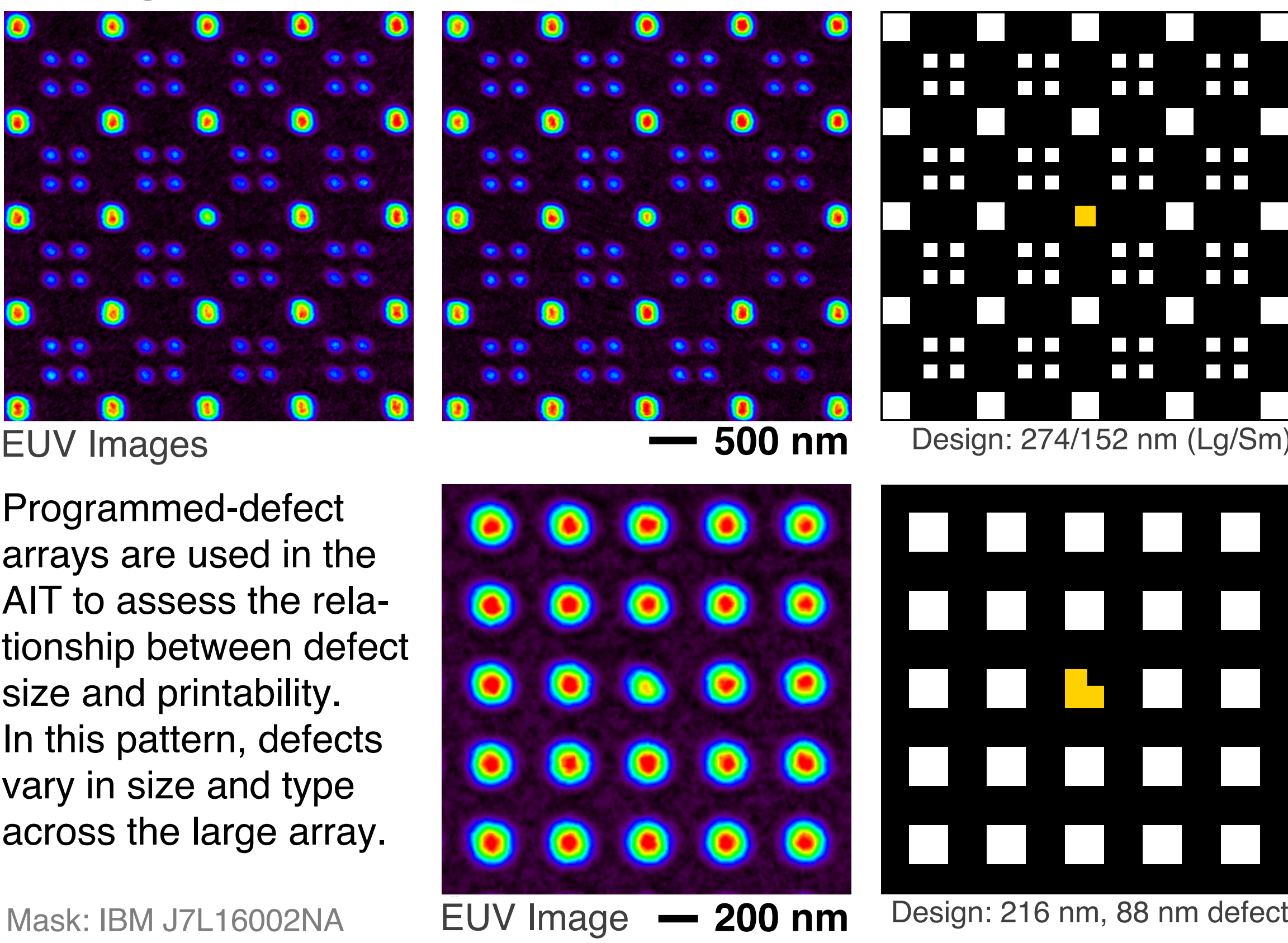
### The current *AIT*

#### AIT Imaging Lens Schematic

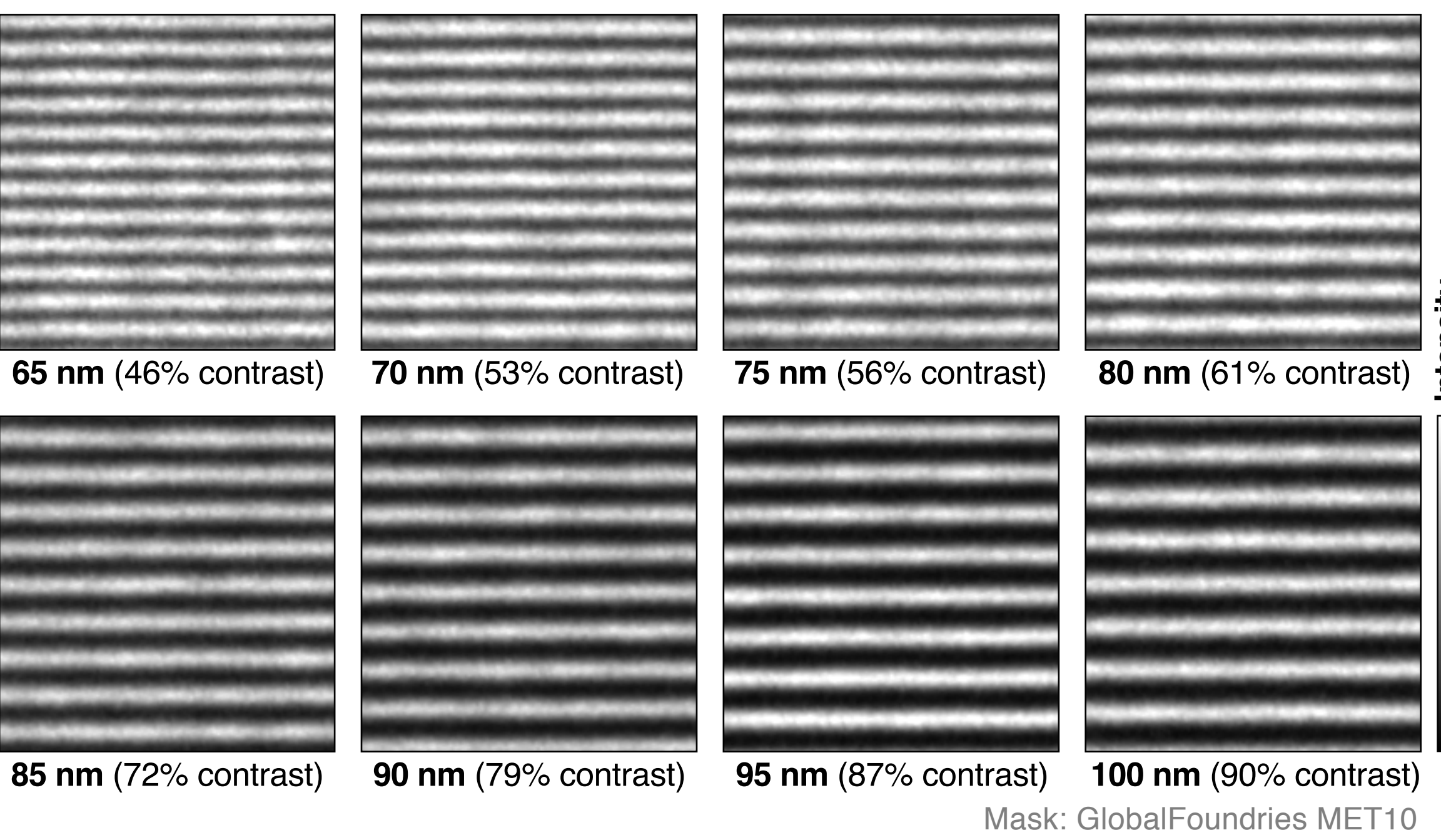


The AIT is the world's first Fresnel zoneplate microscope with an array of interchangeable, high-magnification lenses—made by CXRO's Nanowriter.

#### Programmed Defects

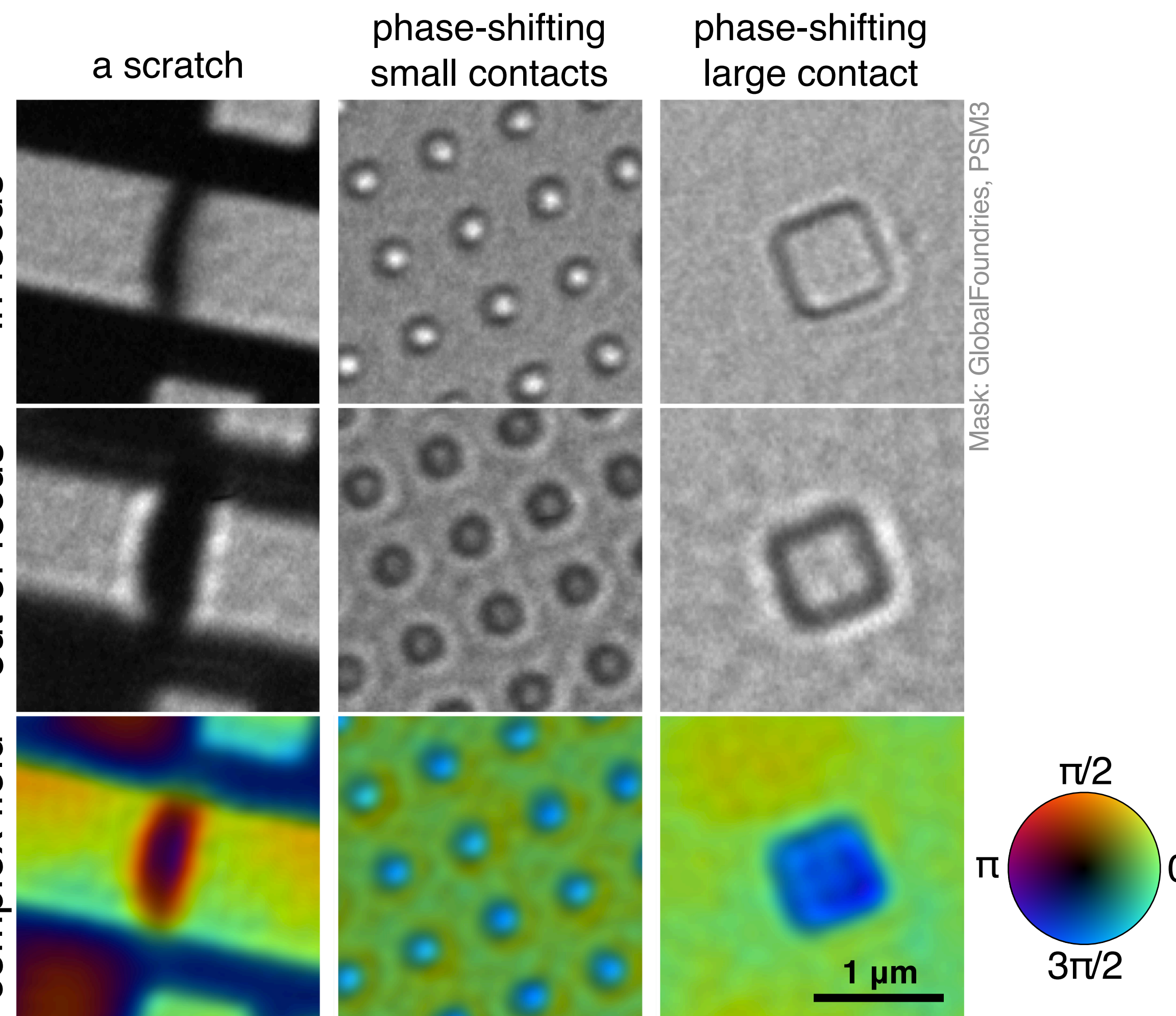


#### Resolution Tests



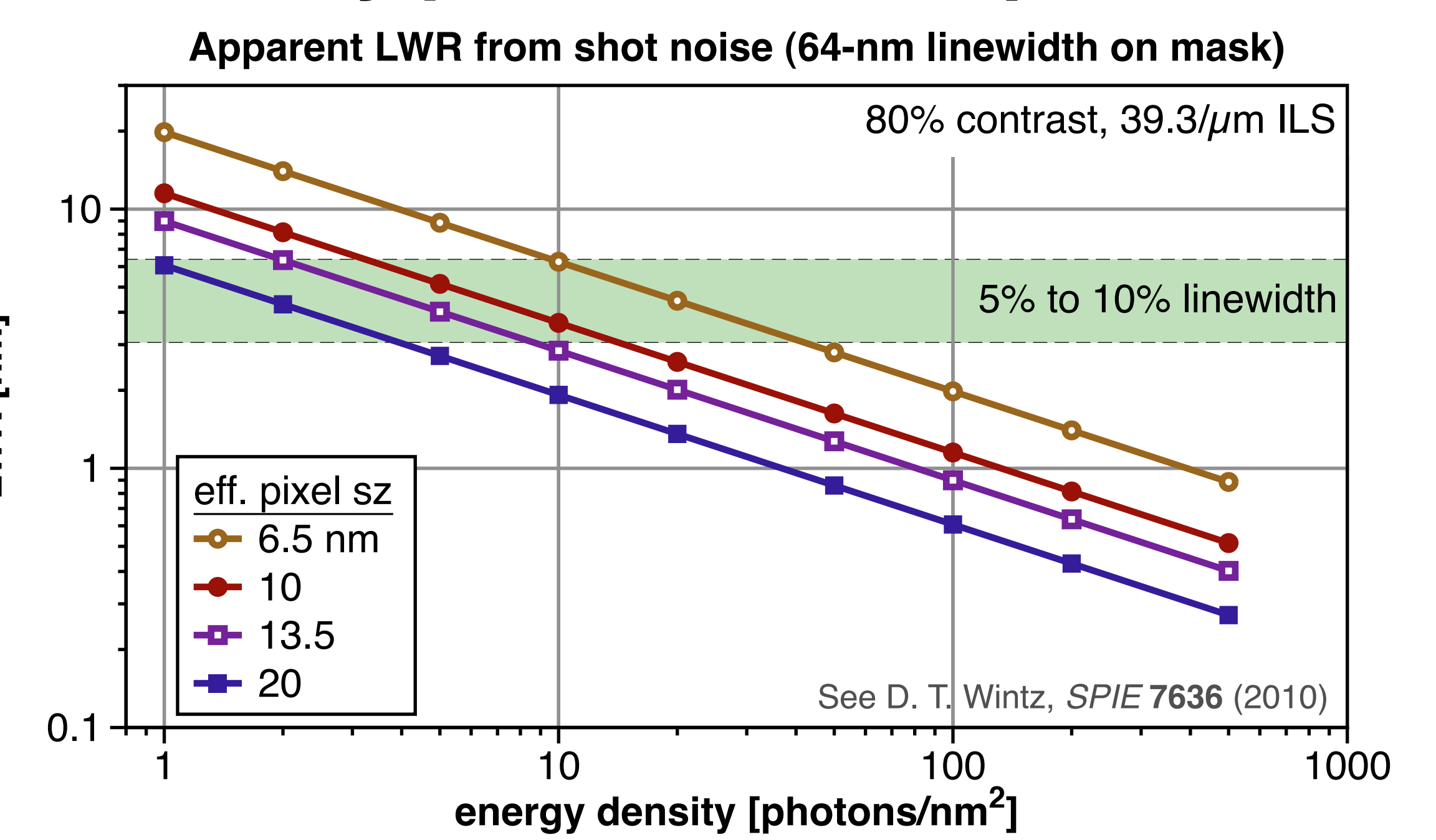
**Line size (half-pitch) and Contrast @ 0.35 NA (4x)**  
In practice, these mask features are printed with 4x reduction.  
We measure new mask architectures and material combinations that can display very different line properties—especially for small features.

#### Measuring the Aerial Image Phase

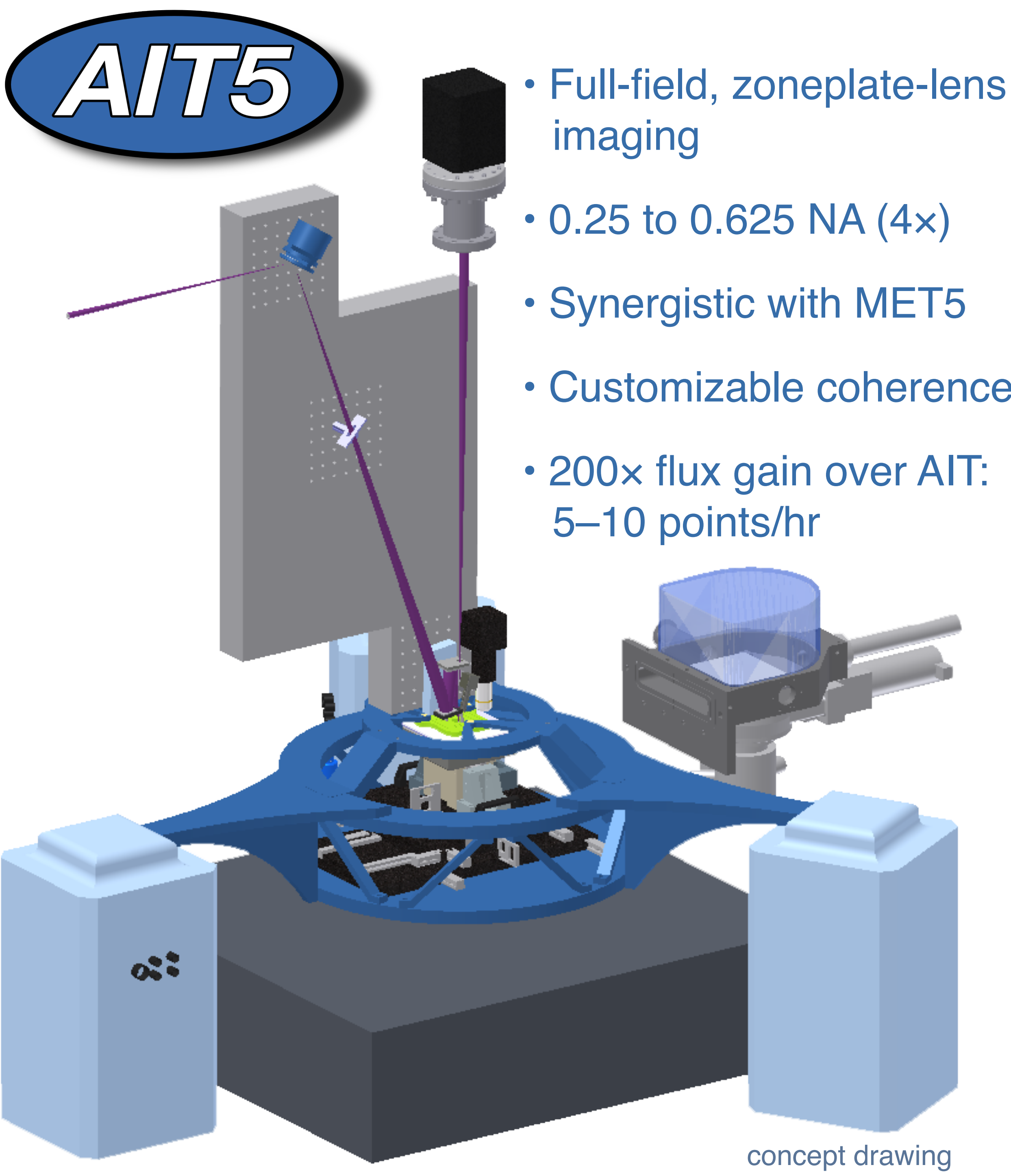


We recently implemented a powerful algorithm to reconstruct the complex aerial image field given multiple through-focus images.

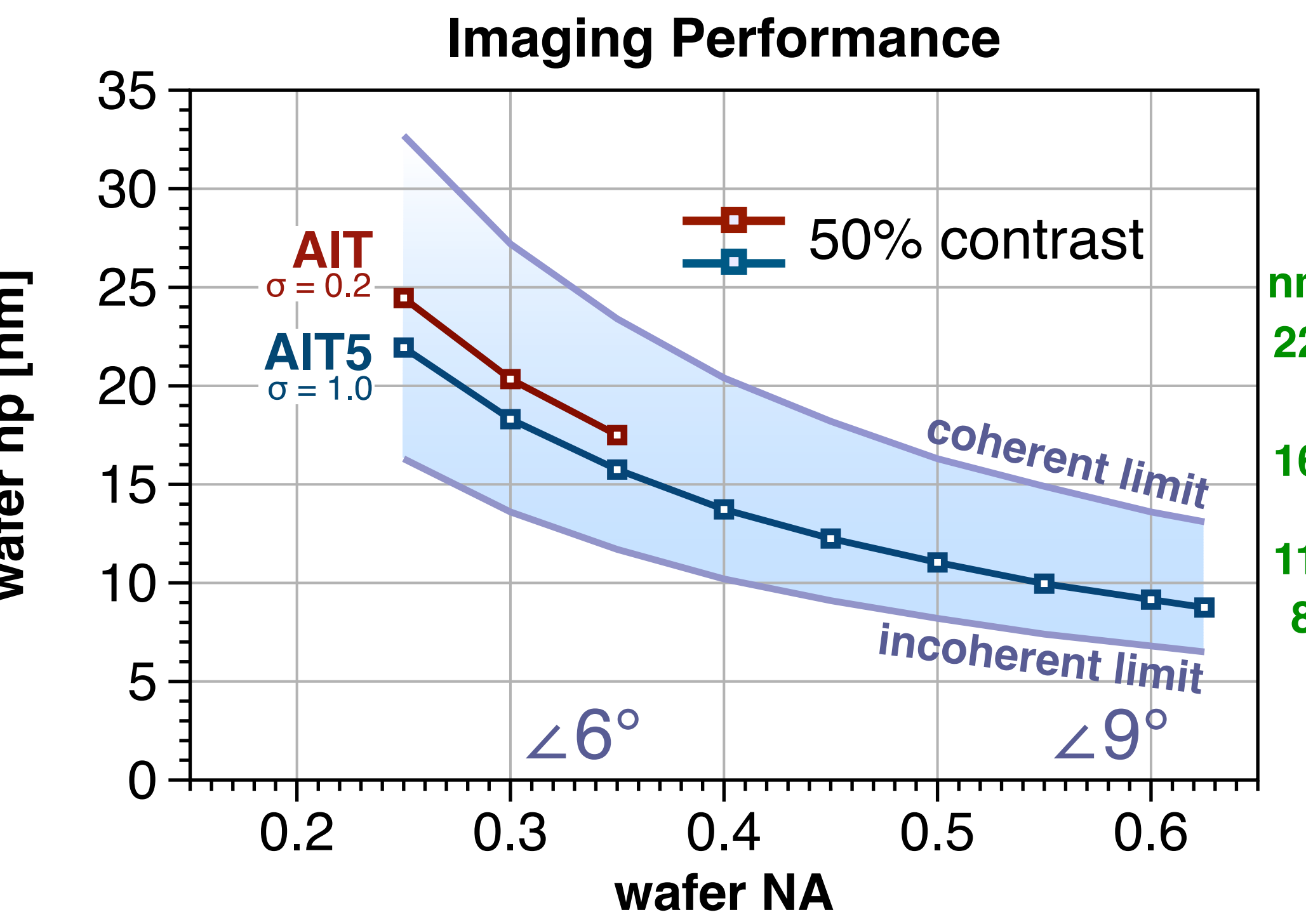
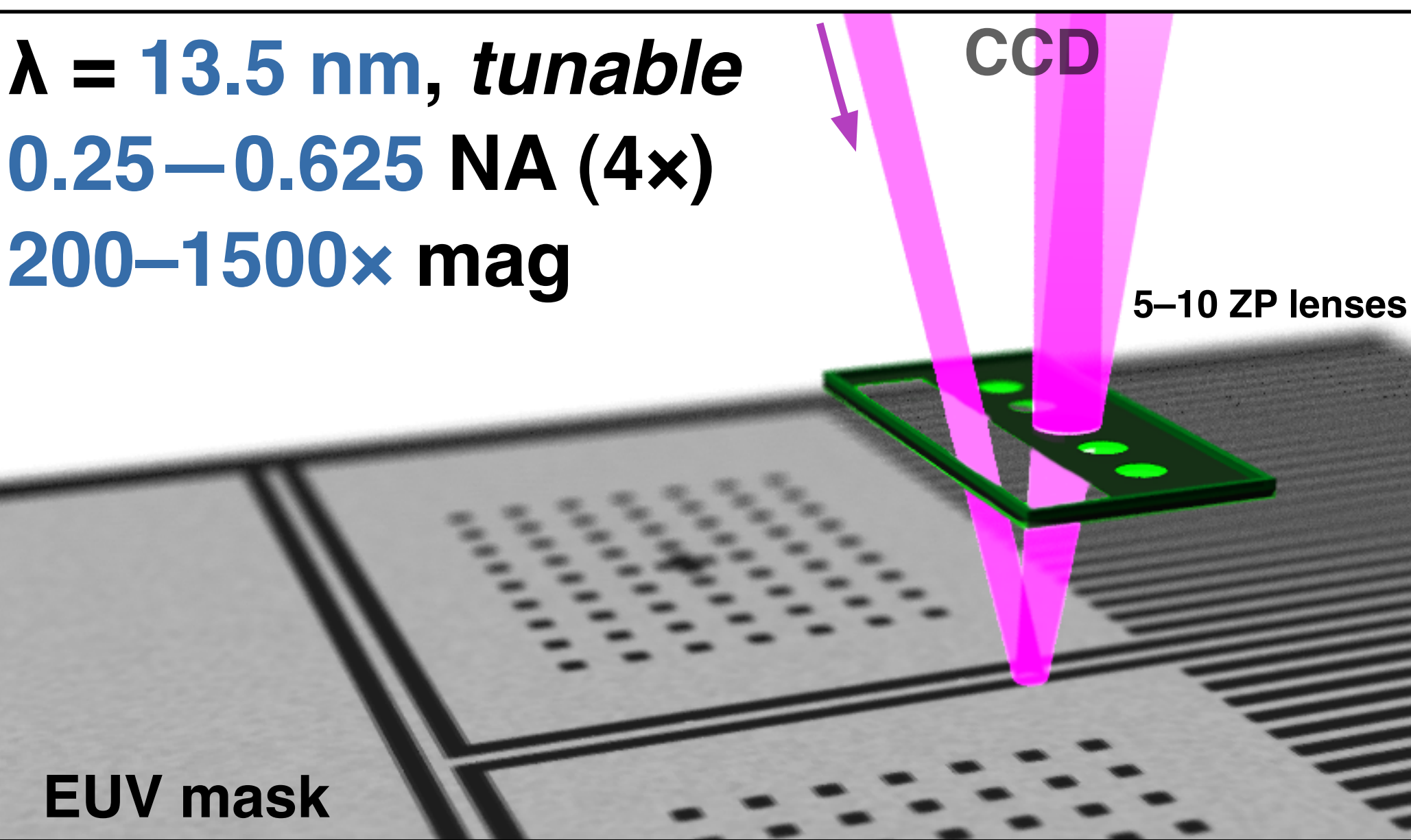
#### How many photons are required?



### The proposed *AIT5*



#### AIT5 Imaging Lens Schematic



#### AIT5 Summary of Advantages

##### Optics and illumination

- Zoneplate lens array (variable NA)
- Coherence and uniformity scanners

##### Efficiency

- Streamlined design for high throughput

##### Synchrotron Source

- Clean, reliable, no cost

##### Navigation

- Integrated visible-light microscope
- Non-contact mask XYZ stage

##### Maintenance

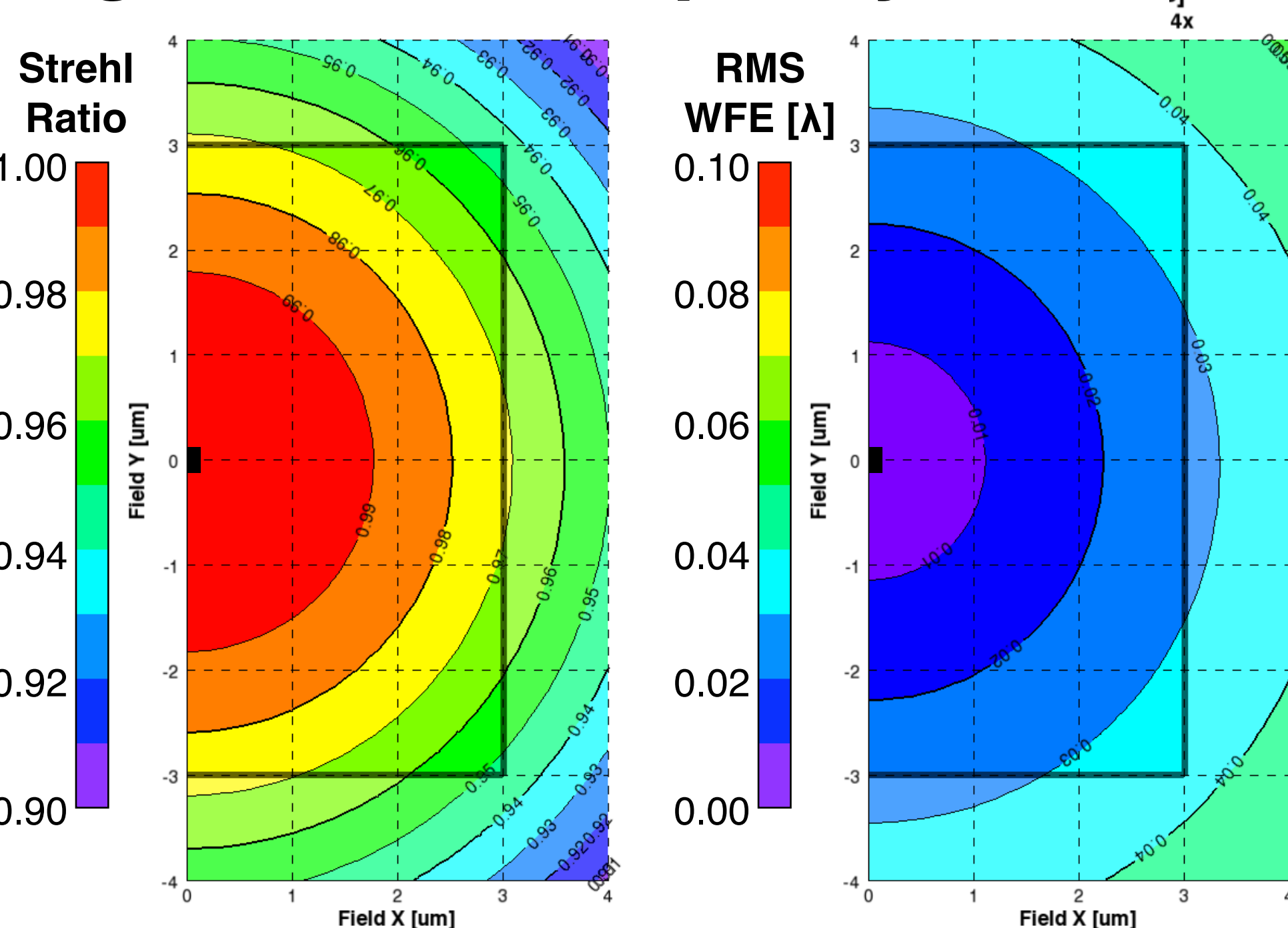
- Accessible architecture
- Straight beam path to CCD

##### LBNL Engineering

- Built by the same team that runs AIT and MET

	AIT	AIT5
<b>Why?</b>	Actinic imaging for essential early learning	Advanced research, to 8-nm; true aerial image testing
<b>mask stage</b>	<i>xyθz (hard navigation)</i>	<i>xyz</i>
<b>zoneplate stage</b>	<i>xyθz</i> , decoupled	<i>xyz</i> , coupled to mask stage
<b>mask e-chuck</b>	non-functional θ alignment problems	working chuck, kinematic loading
<b>vibration isolation</b>	mask surface touching greatly slows work	active isolation, coupled stages
<b><i>in situ</i> vis. microscope</b>	not available	integrated
<b>illumination angle &amp; σ</b>	∠6° & σ ≤ 0.2	∠6–10° & σ ≤ 1
<b>max NA (4x), resolution</b>	0.35, 17.5 nm (wafer)	<b>0.625</b> (or higher), 6.5 nm (wafer)
<b>flux, exposure time</b>	low flux, 45 sec exp.	<b>200× AIT</b> , 1 sec w/ 2x SNR
<b>illumination uniformity</b>	gradients	optimized, flat
<b>system alignment</b>	very challenging	simplified with <i>in situ</i> detectors, pupil-fill monitor
<b>mask loading / handling</b>	manual	SMIF pod / automatic
<b>operators</b>	trained Ph.D.s	technician

#### High wavefront quality can be achieved



**Modeling** predicts excellent wavefront quality, CD uniformity, and minimal HV bias across a 6-μm-wide *sweet spot* at 0.3 NA 4x. The diameter of the aberration-corrected area varies with the ZP focal length and NA.

#### Lossless coherence control

